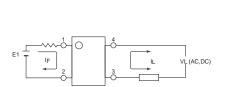
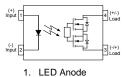
SUPSIC®

Parameter	Symbol	Rating	Units	
Load Voltage	VL	350	V	
Load Current	lι	0.15	Α	
On-Resistance	Ron	17	Ω	
I/O Breakdown Voltage	V/ıo	5000	Vrms	

AC/DC







- 2. LED Cathode
- 3.4. Drain(MOS FET)



SUPSiC PhotoRelays

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- · Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

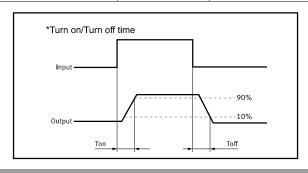
Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- **Energy Management**
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category Output Rating Load Voltage Load Current		Doolsons	Part No.	Packing Quantity	
		Load Current	Package	Part No.	Packing Quantity
AC/DC 350V 0.	0.15A	DIP-4	GAQY210E	100pcs /tube	
	U. 15A	SMD-4	GAQY210EH	2000pcs /reel	





Absolute Maximum Ratings (Ta = 25°C)

	Item	Symbol	Va l ue	Units	Note
	Continuous LED Current	I F	50	mA	
Input	Peak LED Current	I FP	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	Pın	75	mW	
Output	Load Voltage	V∟	350	V(AC peak or DC)	
	Load Current	l.	0.15	Α	
	Peak Load Current	Peak	0.60	Α	100ms(1 pulse)
	Output Power Dissipation	Pout	300	mW	
Total Power	Dissipation	Р⊤	350	mW	
I/O Breakdov	wn Vo l tage	V _{I/O}	5000	Vrms	RH=60%, 1min
Operating Te	emperature	Торг	-40 to 85	°C	
Storage Tem	perature	T _{stg}	-40 to 100	°C	
Pin Soldering	g Temperature	Tsol	260	℃	10 sec max.

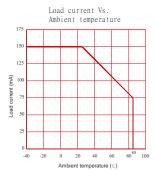
Electrical Characteristics (Ta = 25°C)

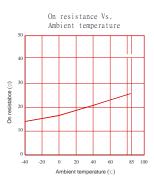
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
Input	LED Forward Voltage	VF		1.2	1.4	٧	I⊧=10mA
	Operation LED Current	Fon		0.5	5.0	mA	
	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	V _{Foff}	0.7			٧	
							I⊧=5mA,I∟=Max
Output	On-Resistance	Ron		17	24	Ω	Time to flow is within 1 sec.
	Off-State Leakage	Leak			1	uA	V∟=Rating
	Current				•		
	Output Capacitance	Cout		115		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.23	0.5	ms	I⊧=5mA, I∟=Max
sion	Turn-Off Time	Toff		0.05	0.2	ms	
Coupled	I/O Isolation Resistance	R _{I/O}	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	C _{I/O}		0.8	1.5	pF	f=1MHz

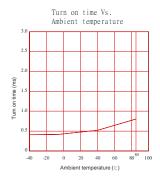
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥ 5 mA and ≤ 30 mA

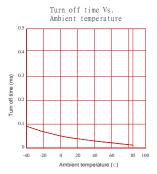


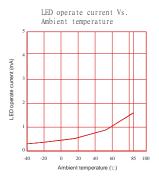
Engineering Data

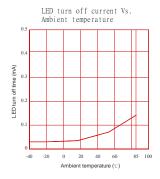


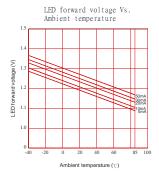


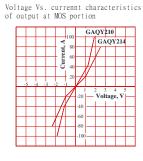


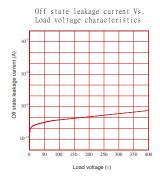


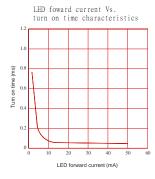


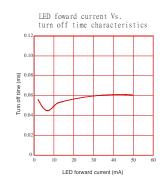


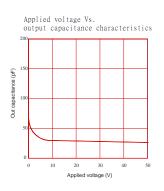












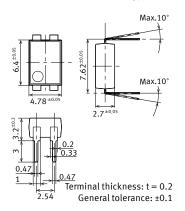


Dimensions and DIP-4 Package

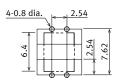
Unit: mm

Marking GAQY 210 YY=YEAR WW=WEEK

Surface mount terminal type



PC board pattern (BOTTOM VIEW)



Tolerance: ±0.1

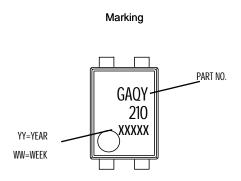
DIP Tape dimensions

Unit: mm inch Tolerance: +0.2 +.007

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



Dimensions and SMD-4 Package Unit: mm

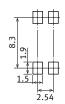


Surface mount terminal type Max.10* 4.78±0.05 2.7±0.05

Terminal thickness: t = 0.2 General tolerance: ±0.1

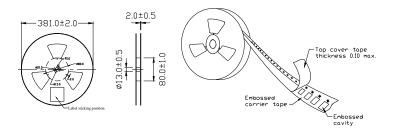
Recommended mounting pad

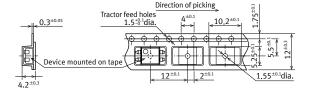
(TOP VIEW)



Tolerance: ±0.1

Tape dimensions (tape reel)

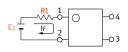


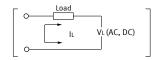




Using Methods

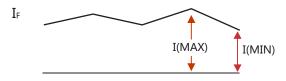
Examples of resistance value to control LED forward current (IF=5mA)





E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9ΚΩ
24V	4.1K Ω

LED forward current must be more than 5mA , at I(MIN) ,and less than 30mA , at I(MAX).



Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

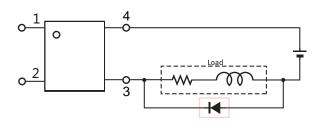
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

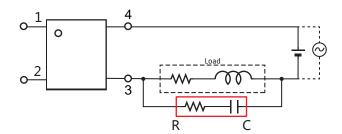
Protection Circuit

Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.